

DNP FID1
DNP FID2
DNP FID3

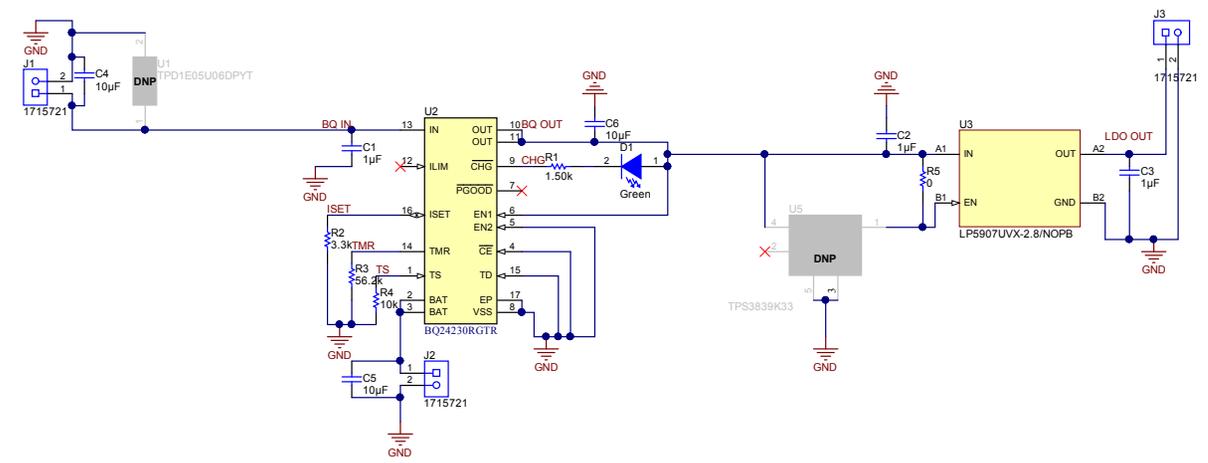
PCB Number: TIDA-00600
PCB Rev: E1

PCB LOGO
Texas Instruments

PCB LOGO
Pb-Free Symbol

Label Table	
Variant	Label Text
001	TIDA-00600

Variant 001:
The DNP devices were not build in or tested with the whole system



- Z22
Assembly Note
These assemblies are ESD sensitive, ESD precautions shall be observed.
- Z23
Assembly Note
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- Z24
Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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